

V_{DRM} = 2800 V
 $I_{T(AV)M}$ = 2625 A
 $I_{T(RMS)}$ = 4120 A
 I_{TSM} = 43×10^3 A
 V_{TO} = 0.85 V
 r_T = 0.16 mΩ

Phase Control Thyristor

5STP 24H2800

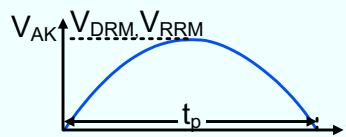
Doc. No. 5SYA1047-03 May 07

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	5STP 24H2800		Unit
Max repetitive peak forward and reverse blocking voltage	V_{DRM} , V_{RRM}	$f = 50$ Hz, $t_p = 10$ ms, $T_{vj} = 5 \dots 125^\circ\text{C}$, Note 1	2800		V
Critical rate of rise of commutating voltage	dv/dt_{crit}	Exp. to 1880 V, $T_{vj} = 125^\circ\text{C}$	1000		V/μs



Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DRM}	V_{DRM} , $T_{vj} = 125^\circ\text{C}$			300	mA
Reverse leakage current	I_{RRM}	V_{RRM} , $T_{vj} = 125^\circ\text{C}$			300	mA

Note 1: Voltage de-rating factor of 0.11% per °C is applicable for T_{vj} below +5 °C

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		45	50	60	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				0.9	kg
Housing thickness	H	$F_M = 50$ kN, $T_a = 25^\circ\text{C}$	25.8		26.4	mm
Surface creepage distance	D_S		36			mm
Air strike distance	D_a		15			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.

On-state

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70^\circ\text{C}$			2625	A
RMS on-state current	$I_{T(RMS)}$				4120	A
Peak non-repetitive surge current	I_{TSM}	$t_p = 10 \text{ ms}, T_{vj} = 125^\circ\text{C}$, sine wave after surge: $V_D = V_R = 0 \text{ V}$			43×10^3	A
Limiting load integral	I^2t				9.25×10^6	A^2s
Peak non-repetitive surge current	I_{TSM}	$t_p = 8.3 \text{ ms}, T_{vj} = 125^\circ\text{C}$, sine wave after surge: $V_D = V_R = 0 \text{ V}$			46×10^3	A
Limiting load integral	I^2t				8.78×10^6	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 3000 \text{ A}, T_{vj} = 125^\circ\text{C}$			1.35	V
Threshold voltage	$V_{(TO)}$	$I_T = 1500 \text{ A} - 4500 \text{ A}, T_{vj} = 125^\circ\text{C}$			0.85	V
Slope resistance	r_T				0.16	$\text{m}\Omega$
Holding current	I_H	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$			75	mA
Latching current	I_L				60	mA
		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$			600	mA
					200	mA

Switching

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	$T_{vj} = 125^\circ\text{C}, I_{TRM} = 3000 \text{ A}, f = 50 \text{ Hz}$			150	$\text{A}/\mu\text{s}$
Critical rate of rise of on-state current	di/dt_{crit}	$V_D \leq 1880 \text{ V}, I_{FG} = 2 \text{ A}, t_r = 0.5 \mu\text{s}$			1000	$\text{A}/\mu\text{s}$
Circuit-commutated turn-off time	t_q	$T_{vj} = 125^\circ\text{C}, I_{TRM} = 2000 \text{ A}, V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu\text{s}, V_D \leq 0.67 \cdot V_{DRM}, dv_D/dt = 20 \text{ V}/\mu\text{s}$	400			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	Q_{rr}	$T_{vj} = 125^\circ\text{C}, I_{TRM} = 2000 \text{ A}, V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu\text{s}$	650		1700	μAs
Reverse recovery current	I_{RM}		30		50	A
Gate turn-on delay time	t_{gd}	$T_{vj} = 25^\circ\text{C}, V_D = 0.4 \cdot V_{RM}, I_{FG} = 2 \text{ A}, t_r = 0.5 \mu\text{s}$			3	μs

Triggering

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V_{FGM}				12	V
Peak forward gate current	I_{FGM}				10	A
Peak reverse gate voltage	V_{RGM}				10	V
Average gate power loss	$P_{G(AV)}$		see Fig. 9			W

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	V_{GT}	$T_{vj} = 25^\circ C$			2.6	V
Gate-trigger current	I_{GT}	$T_{vj} = 25^\circ C$			400	mA
Gate non-trigger voltage	V_{GD}	$V_D = 0.4 \times V_{DRM}, T_{vjmax} = 125^\circ C$	0.3			V
Gate non-trigger current	I_{GD}	$V_D = 0.4 \times V_{DRM}, T_{vjmax} = 125^\circ C$	10			mA

Thermal

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}				125	°C
Storage temperature range	T_{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 45...60$ kN			10	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 45...60$ kN			20	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 45...60$ kN			20	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 45...60$ kN			2	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 45...60$ kN			4	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(K/kW)$	6.520	1.550	1.670	0.490
$\tau_i(s)$	0.4562	0.0792	0.0088	0.0037

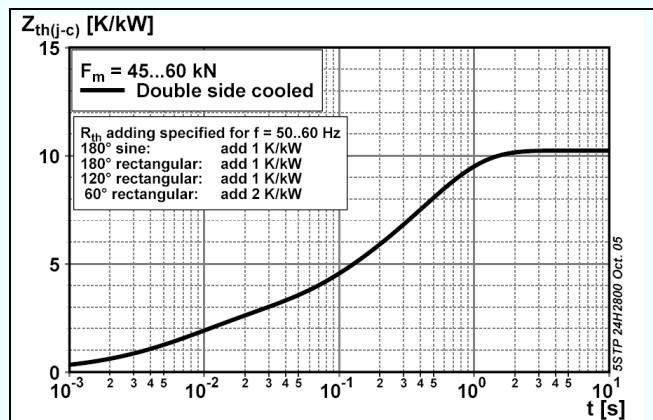


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

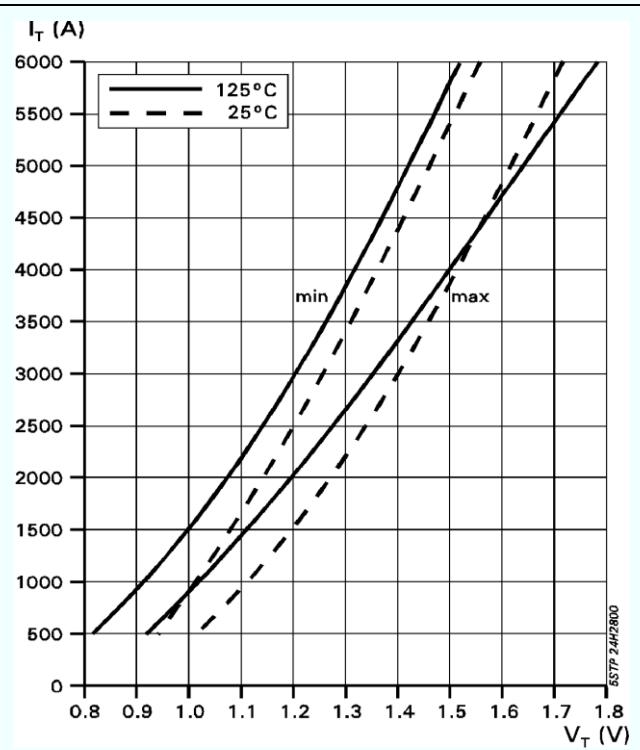


Fig. 2 On-state voltage characteristics

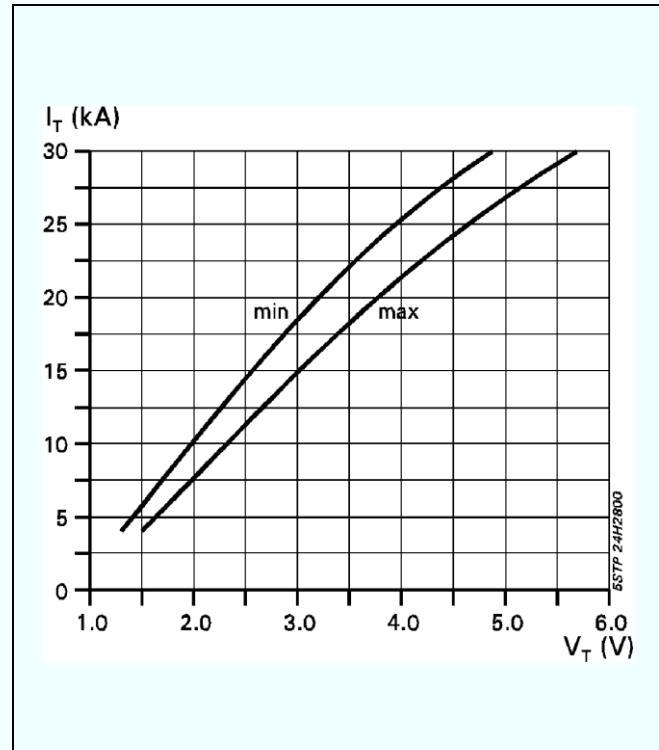
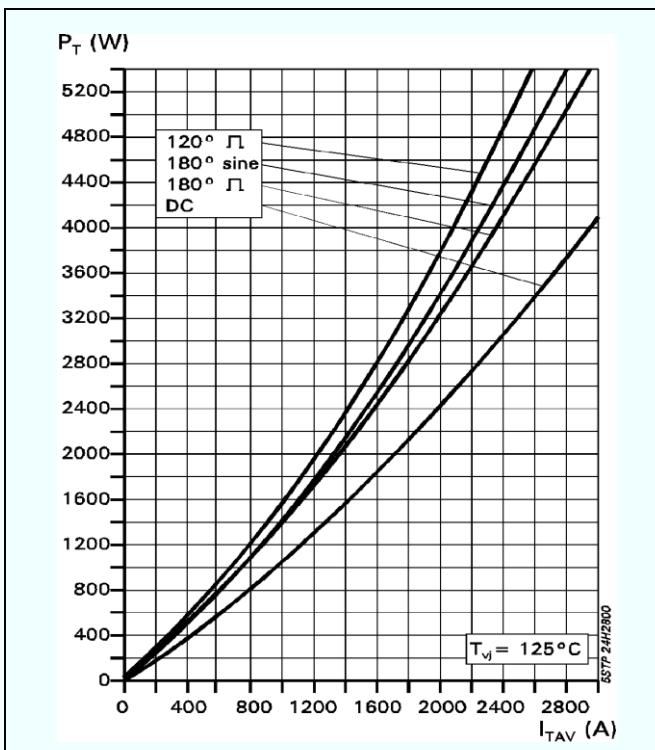
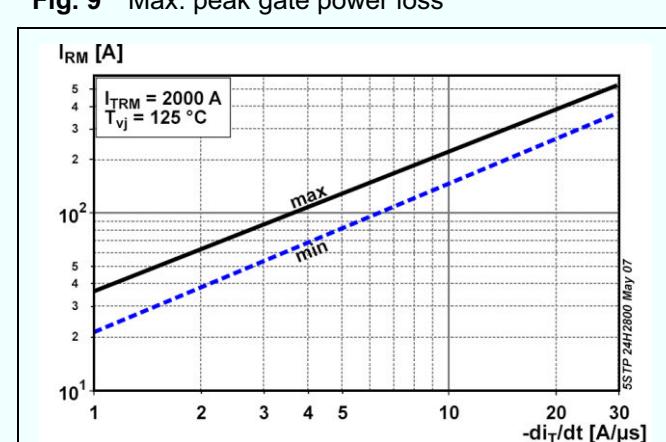
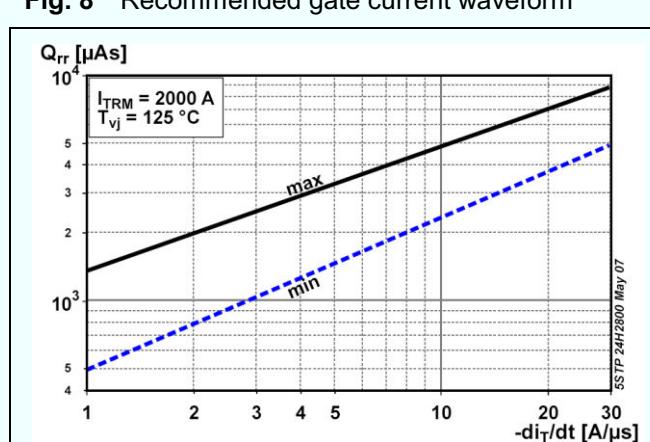
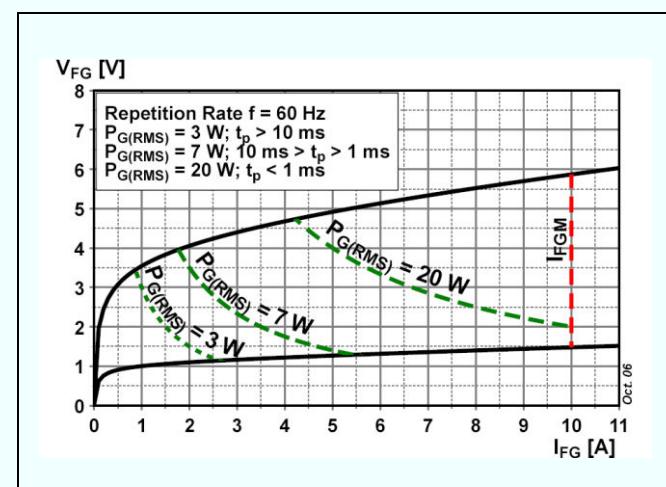
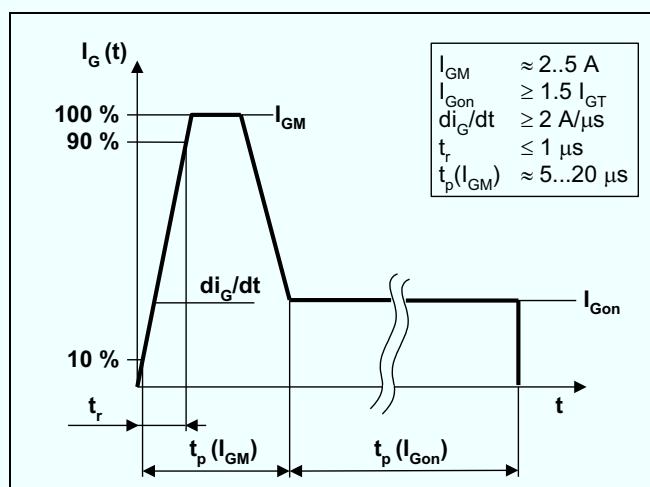
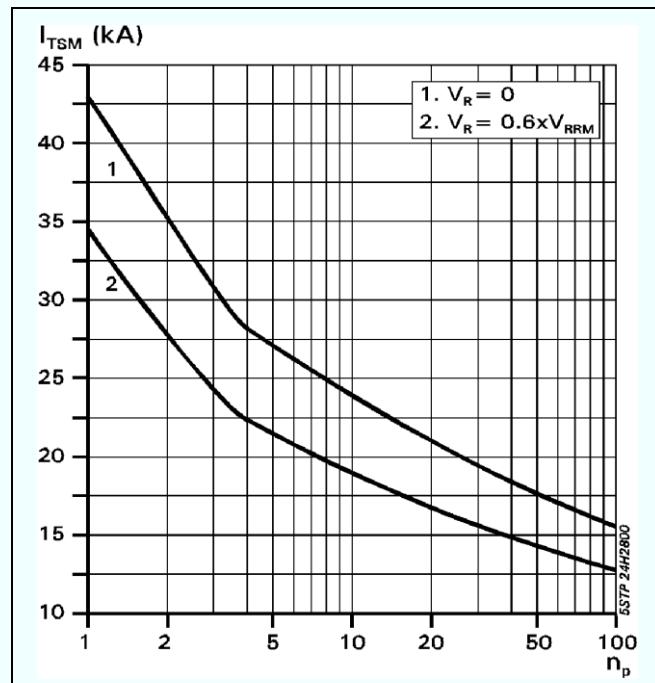
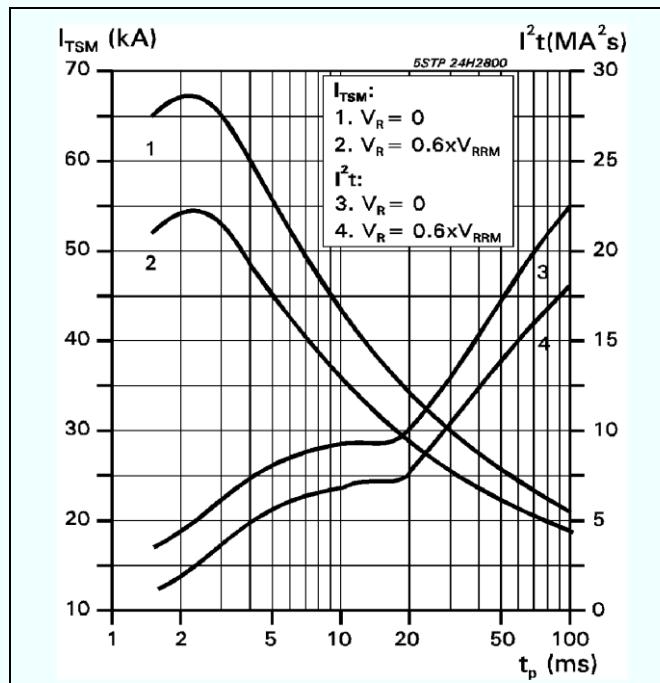
Fig. 3 On-state characteristics,
 $T_j = 125^\circ\text{C}$, 10ms half sine

Fig. 4 On-state power dissipation vs. mean on-state current, turn-on losses excluded



Fig. 5 Max. permissible case temperature vs. mean on-state current, switching losses ignored



Turn-on and Turn-off losses

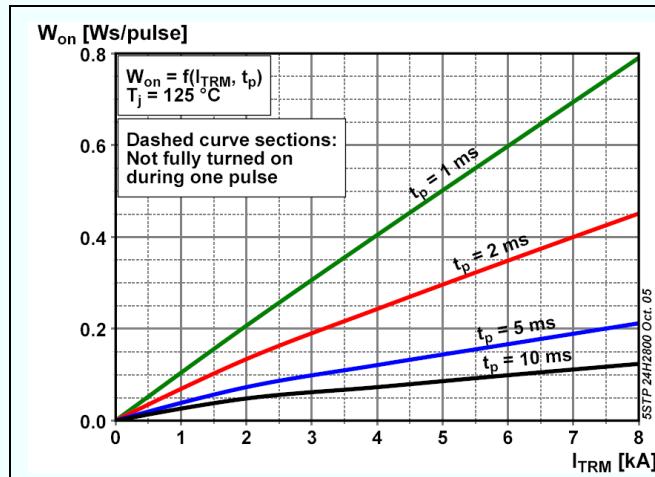


Fig. 12 Turn-on energy, half sinusoidal waves

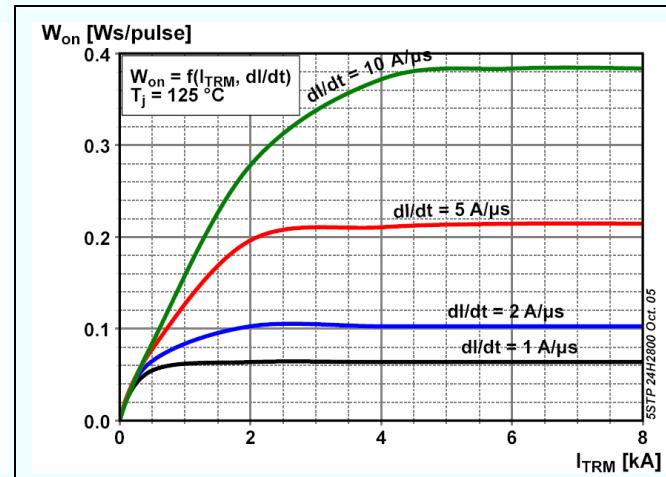


Fig. 13 Turn-on energy, rectangular waves

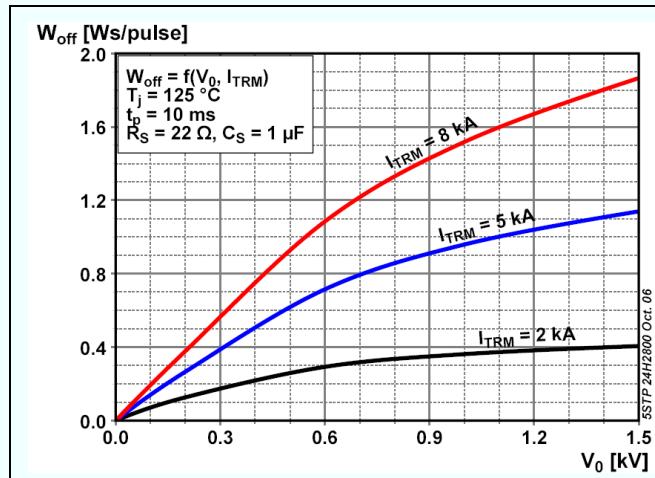


Fig. 14 Turn-off energy, half sinusoidal waves

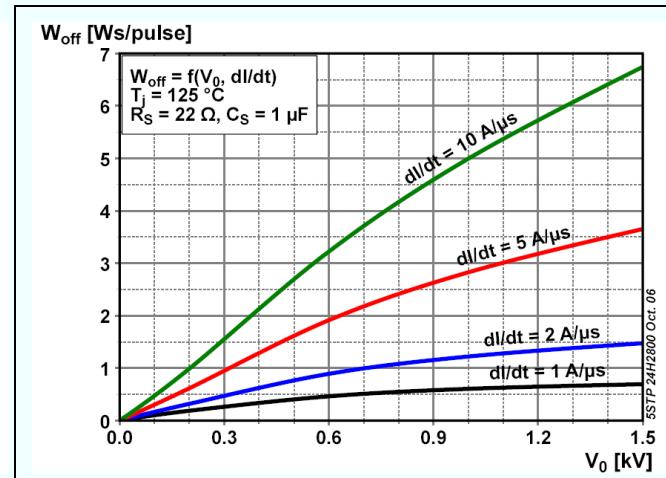


Fig. 15 Turn-off energy, rectangular waves

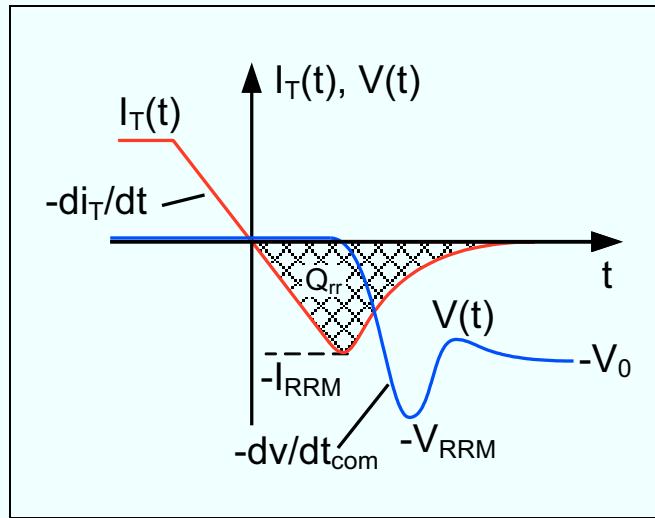


Fig. 16 Current and voltage waveforms at turn-off

Total power loss for repetitive waveforms:

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T) dt$$

Fig. 17 Relationships for power loss

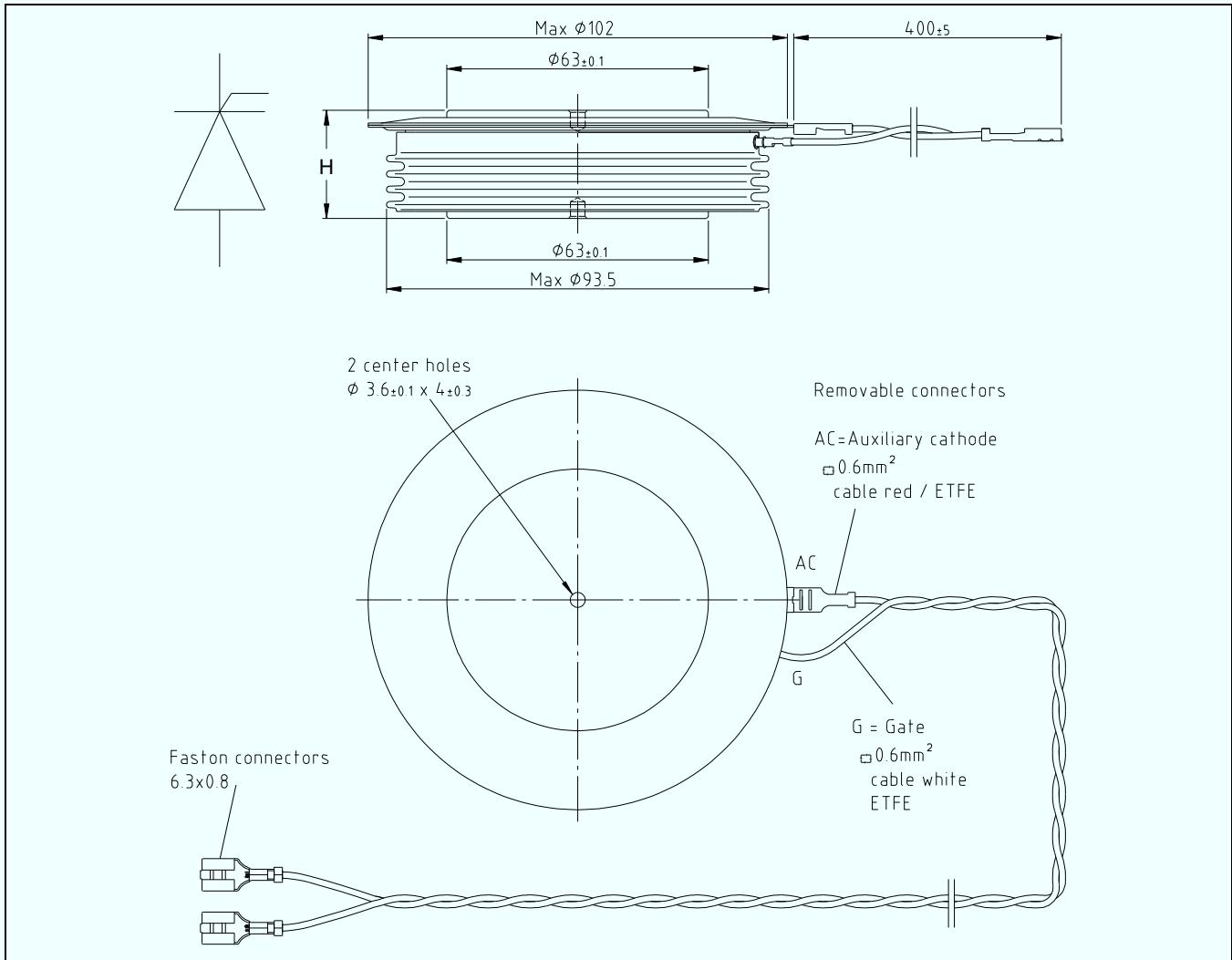


Fig. 18 Device Outline Drawing

Highest Version: 04 / IN (init)

Related documents:

- 5SYA 2020 Design of RC-Snubber for Phase Control Applications
- 5SYA 2049 Voltage definitions for phase control thyristors and diodes
- 5SYA 2051 Voltage ratings of high power semiconductors
- 5SYA 2034 Gate-Drive Recommendations for PCT's
- 5SYA 2036 Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
- 5SZK 9104 Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory
- 5SZK 9105 Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



ABB Switzerland Ltd
Semiconductors
Fabrikstrasse 3
CH-5600 Lenzburg, Switzerland

Doc. No. 5SYA1047-03 May 07

Telephone +41 (0)58 586 1419
Fax +41 (0)58 586 1306
Email abbsem@ch.abb.com
Internet www.abb.com/semiconductors

RE(released)